

TMR130x

MicroAmpere High Frequency Response Omnipolar Magnetic Switch Sensor

Description

TMR130x is an omnipolar magnetic switch integrated the tunnel magnetoresistance (TMR) magnetic sensor and CMOS circuitry, which is able to detect the change of magnetic field and output high and low voltage signals for high accuracy position detection.

Unlike Hall/AMR sensors, TMR sensors with extremely high resistance values allows TMR130x to achieve the supply current as low as 1.5 μA while operating in the full-time power supply mode, and maintaining the response frequency of the magnetic signal is greater than 1 kHz. Therefore, TMR130x can provide true continuous detection of magnetic field signals, avoiding sampling errors from the traditional time-sharing power supply mode.

TMR130x allows a wide range of operating supply voltages from 1.8 V to 5.5 V with excellent temperature characteristics, and can meet the requirements of most applications.

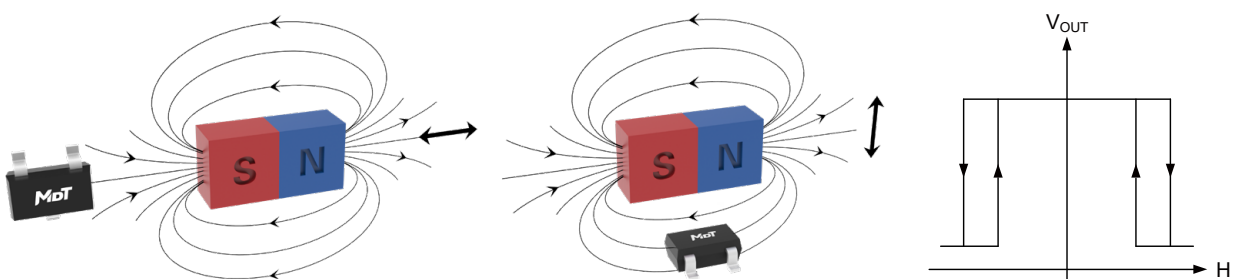
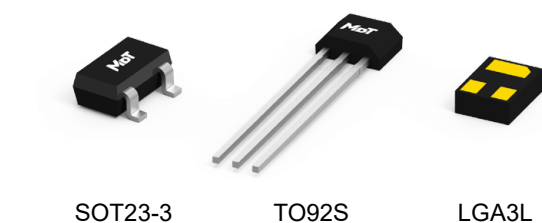
TMR130x is available in three compact SOT23-3, TO92S and LGA3L (2 mm \times 1.5 mm \times 0.63 mm) packages.

Features and benefits

- Tunneling magnetoresistance (TMR) technology
- Low power consumption: supply current 1.5 μA
- High frequency response: >1 kHz
- Omnipolar operation
- Wide range supply voltages: 1.8 V to 5.5 V
- CMOS push-pull output
- High sensitivity
- Excellent temperature stability
- High tolerance to external magnetic field interference
- RoHS & REACH compliant

Applications

- Utility meters: water, gas, and heat meters
- Proximity switches
- Speed sensing
- Linear and rotation position sensing



Selection Guide

Part Number	Supply Current	Response Frequency	Operating Ambient Temperature	Operating Point	Release Point	Package	Packing Form
TMR1302S	1.5 μ A	1 kHz	-40 °C to 125 °C	± 17 Gs	± 10 Gs	SOT23-3	Tape & Reel
TMR1302T	1.5 μ A	1 kHz	-40 °C to 125 °C	± 17 Gs	± 10 Gs	TO92S	ESD Bag
TMR1302G	1.5 μ A	1 kHz	-40 °C to 125 °C	± 17 Gs	± 10 Gs	LGA3L	Tape & Reel
TMR1302HS	1.5 μ A	5 kHz	-40 °C to 125 °C	± 17 Gs	± 10 Gs	SOT23-3	Tape & Reel
TMR1302HT	1.5 μ A	5 kHz	-40 °C to 125 °C	± 17 Gs	± 10 Gs	TO92S	ESD Bag
TMR1302HTS	1.5 μ A	5 kHz	-40 °C to 150 °C	± 17 Gs	± 10 Gs	SOT23-3	Tape & Reel
TMR1302HTT	1.5 μ A	5 kHz	-40 °C to 150 °C	± 17 Gs	± 10 Gs	TO92S	ESD Bag
TMR1303S	1.5 μ A	1 kHz	-40 °C to 125 °C	± 35 Gs	± 22 Gs	SOT23-3	Tape & Reel
TMR1303T	1.5 μ A	1 kHz	-40 °C to 125 °C	± 35 Gs	± 22 Gs	TO92S	ESD Bag
TMR1304S	1.5 μ A	1 kHz	-40 °C to 125 °C	± 10 Gs	± 5 Gs	SOT23-3	Tape & Reel
TMR1304T	1.5 μ A	1 kHz	-40 °C to 125 °C	± 10 Gs	± 5 Gs	TO92S	ESD Bag
TMR1308S	1.5 μ A	1 kHz	-40 °C to 125 °C	± 5 Gs	± 3 Gs	SOT23-3	Tape & Reel
TMR1308T	1.5 μ A	1 kHz	-40 °C to 125 °C	± 5 Gs	± 3 Gs	TO92S	ESD Bag
Note: Please contact MultiDimension Technology local sales for customizing operating and release points.							

Catalogue

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1. Functional Block Diagram

TMR130x series switch chips are composed of TMR sensors and signal processing circuits. The TMR sensor detects external magnetic field, generates an analog voltage signal, and outputs a logical switch level after processing by the circuits as shown in Figure 1.

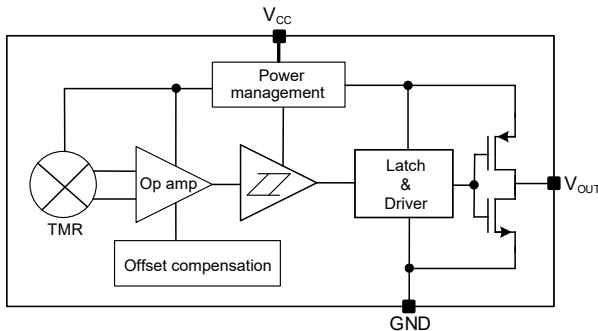


Figure 1. Block diagram

2. Switching Characteristics

The Figure 2 shows the sensing direction is parallel to the silkscreen surface of the package as shown by the arrow.

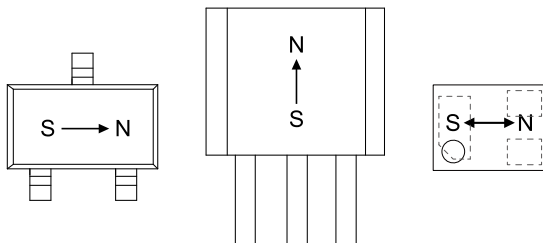


Figure 2. Sensing direction

The output is “High”, when power is on at zero magnetic field. B is the external magnetic field along the sensing direction, B_{OPS} (B_{OPN}) is the operating point, B_{RPS} (B_{RPN}) is the release point, and hysteresis B_H is define as the difference between B_{OPS} and B_{RPS} (B_{OPN} and B_{RPN}).

The sensor outputs a low level, when the magnetic field along the sensing axis exceeds the operate point B_{OPS} (B_{OPN}), and the device outputs a high level, when the magnetic field is reduced below the release point B_{RPS} (B_{RPN}) as shown in Figure 3.

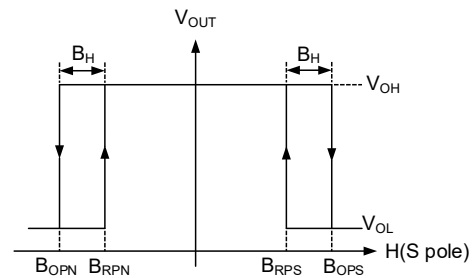


Figure 3. Switching characteristics

3. Pin Configuration

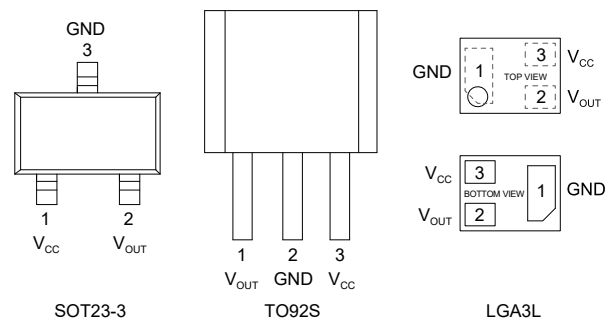


Figure 4. Pin configuration

Pin Number			Name	Function
SOT23-3	TO92S	LGA3L		
1	3	3	V_{CC}	Power supply
2	1	2	V_{OUT}	Output
3	2	1	GND	Ground

4. Absolute Maximum Ratings

Parameters	Symbol	Min.	Max.	Unit	Applicable Part Number
Supply voltage	V_{CC}	-0.3	7	V	All parts
Output current	I_{SINK} and I_{SOURCE}	-	9	mA	All parts
Magnetic flux density	B	-	4000	Gs	All parts
ESD performance (HBM)	V_{ESD}	-	4	kV	All parts
Operating ambient temperature	T_A	-40	125	°C	All parts
		-50	150	°C	TMR1302HTx
Storage ambient temperature	T_{STG}	-50	150	°C	All parts

Note: I_{SINK} is the current flowing through the high side MOSFET, when the high side MOSFET is turned on, and I_{SOURCE} is the current flowing through the low side MOSFET when the low side MOSFET is turned on.

5. Electrical Specifications

$V_{CC} = 3\text{ V}$, $T_A = 25\text{ °C}$, a 0.1 μF capacitor is connected between V_{CC} and GND

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Applicable Part Number
Supply voltage	V_{CC}	operating	1.8	3.0	5.5	V	All parts
Output high voltage	V_{OH}	RP status	$V_{CC}-0.3$	-	V_{CC}	V	All parts
Output low voltage	V_{OL}	OP status	0	-	0.2	V	All parts
Supply current	I_{CC}	output open	0.5	1.5	2	μA	All parts
Response frequency	F	-	0 to 1000			Hz	All parts
			0 to 5000			Hz	TMR1302Hx, TMR1302HTx

6. Magnetic Specifications

$V_{CC} = 3\text{ V}$, $T_A = 25\text{ °C}$, a 0.1 μF capacitor is connected between V_{CC} and GND

TMR1302x, TMR1302Hx, TMR1302HTx

Parameter	Symbol	Min.	Typ.	Max.	Unit
Operate point	B_{OPS}	10	17	25	Gs
	B_{OPN}	-25	-17	-10	Gs
Release point	B_{RPS}	5	10	20	Gs
	B_{RPN}	-20	-10	-5	Gs
Hysteresis	B_H	3	-	16	Gs

TMR1303x

Parameter	Symbol	Min.	Typ.	Max.	Unit
Operate point	B _{OPS}	23	35	47	Gs
	B _{OPN}	-47	-35	-23	Gs
Release point	B _{RPS}	10	22	40	Gs
	B _{RPN}	-40	-22	-10	Gs
Hysteresis	B _H	3	-	16	Gs

TMR1304x

Parameter	Symbol	Min.	Typ.	Max.	Unit
Operate point	B _{OPS}	6	10	14	Gs
	B _{OPN}	-14	-10	-6	Gs
Release point	B _{RPS}	3	5	10	Gs
	B _{RPN}	-10	-5	-3	Gs
Hysteresis	B _H	2	-	7	Gs

TMR1308x

Parameter	Symbol	Min.	Typ.	Max.	Unit
Operate point	B _{OPS}	3	5	9	Gs
	B _{OPN}	-9	-5	-3	Gs
Release point	B _{RPS}	2.5	3	7	Gs
	B _{RPN}	-7	-3	-2.5	Gs
Hysteresis	B _H	0.5	-	6.5	Gs

7. Typical Supply Voltage Characteristics

TMR1302x, TMR1302Hx, TMR1302HTx Supply Voltage Characteristics

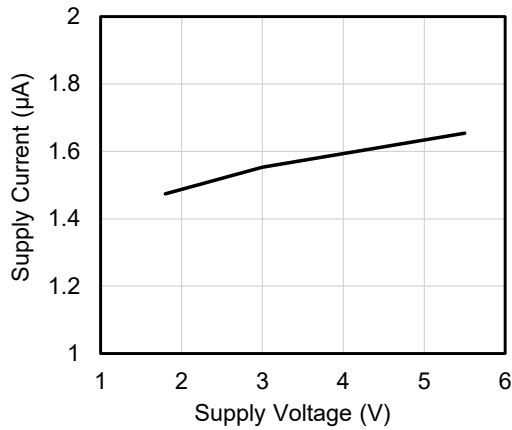


Figure 5. Supply current versus supply voltage ($T_A=25^{\circ}\text{C}$)

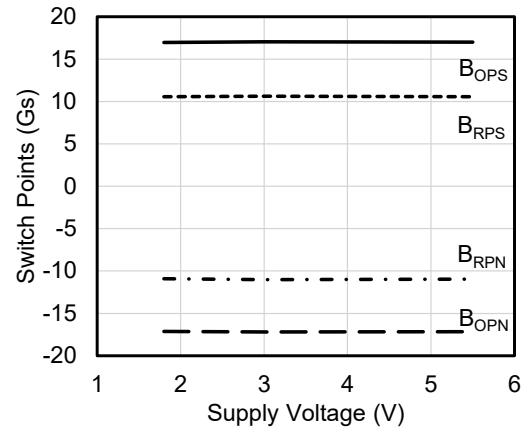


Figure 6. Switch points versus supply voltage ($T_A=25^{\circ}\text{C}$)

TMR1303x Supply Voltage Characteristics

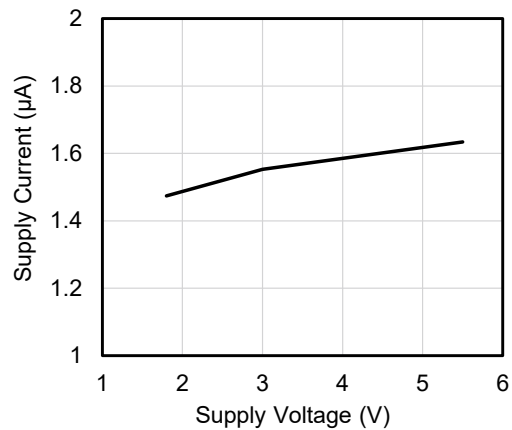


Figure 7. Supply current versus supply voltage ($T_A=25^{\circ}\text{C}$)

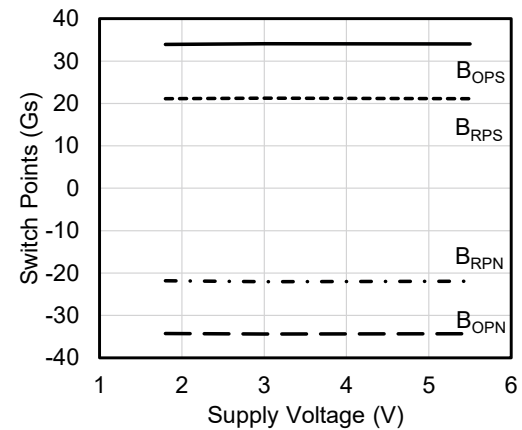


Figure 8. Switch points versus supply voltage ($T_A=25^{\circ}\text{C}$)

TMR1304x Supply Voltage Characteristics

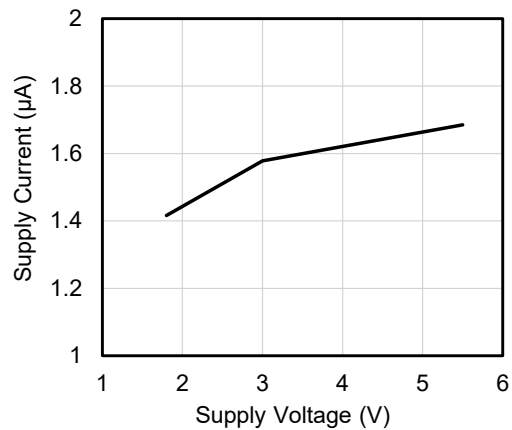


Figure 9. Supply current versus supply voltage ($T_A=25^{\circ}\text{C}$)

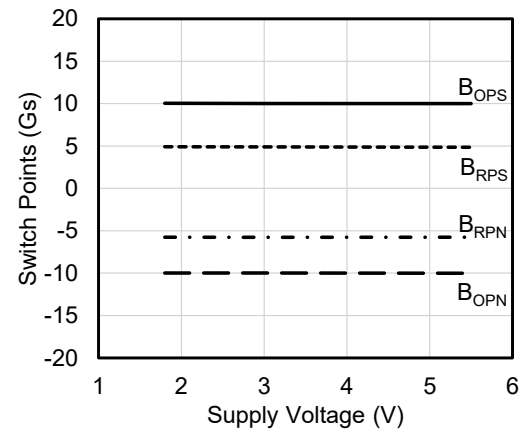


Figure 10. Switch points versus supply voltage ($T_A=25^{\circ}\text{C}$)

TMR1308x Supply Voltage Characteristics

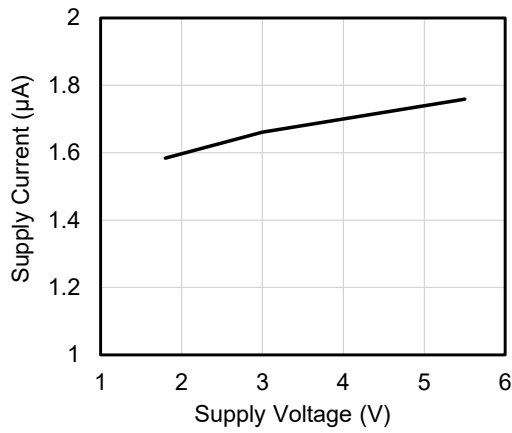


Figure 11. Supply current versus supply voltage ($T_A=25^{\circ}\text{C}$)

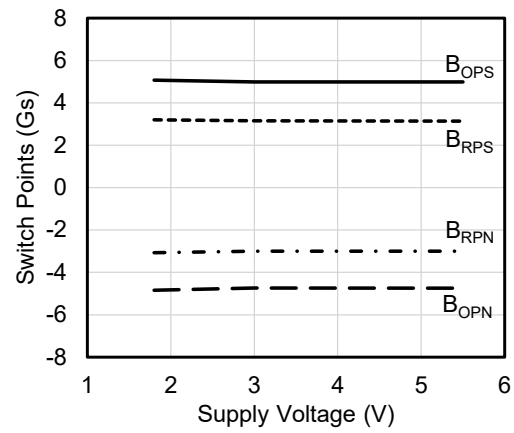


Figure 12. Switch points versus supply voltage ($T_A=25^{\circ}\text{C}$)

8. Typical Temperature Characteristics

TMR1302x, TMR1302Hx Temperature Characteristics

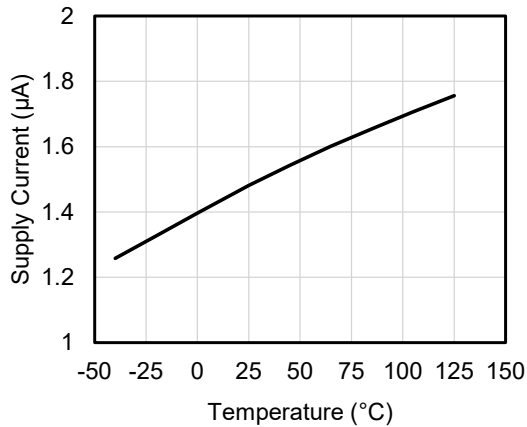


Figure 13. Supply current versus temperature ($V_{CC} = 3\text{ V}$)

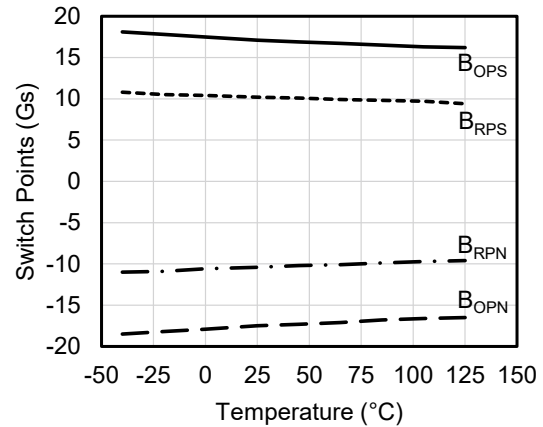


Figure 14. Switch points versus temperature ($V_{CC} = 3\text{ V}$)

TMR1302HTx Temperature Characteristics

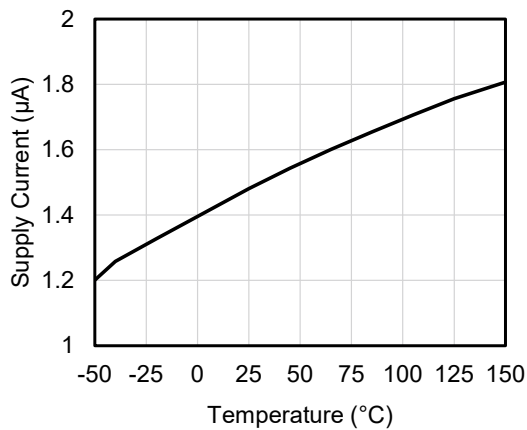


Figure 15. Supply current versus temperature ($V_{CC} = 3\text{ V}$)

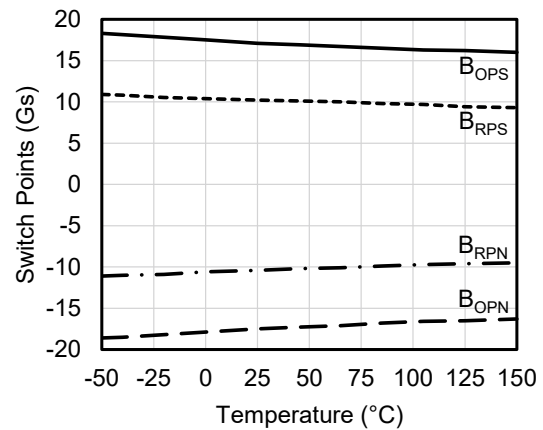


Figure 16. Switch points versus temperature ($V_{CC} = 3\text{ V}$)

TMR1303x Temperature Characteristics

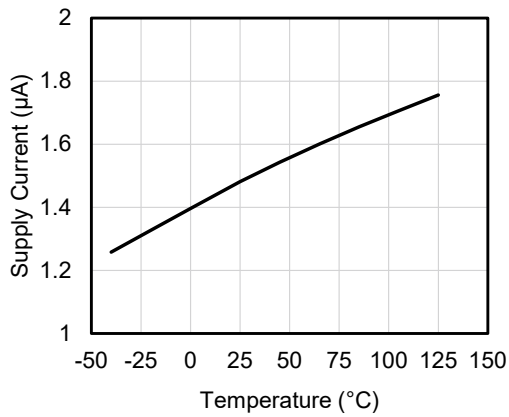


Figure 17. Supply current versus temperature ($V_{CC} = 3\text{ V}$)

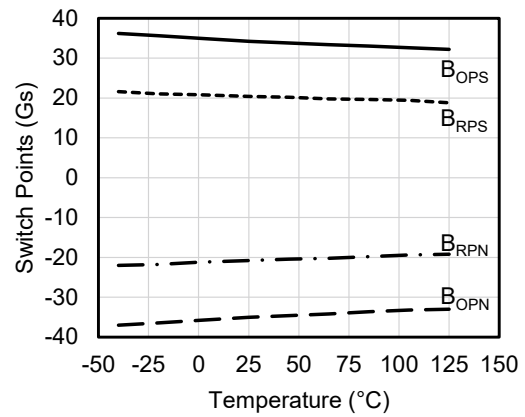


Figure 18. Switch points versus temperature ($V_{CC} = 3\text{ V}$)

TMR1304x Temperature Characteristics

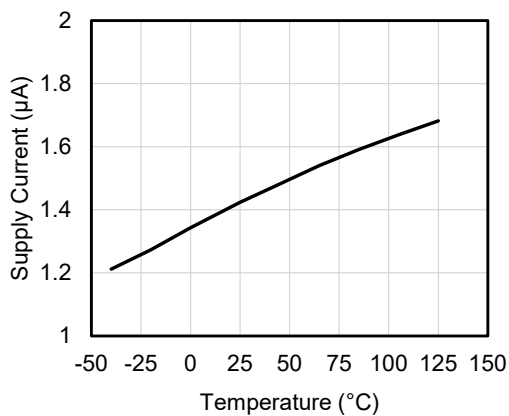


Figure 19. Supply current versus temperature ($V_{CC} = 3\text{ V}$)

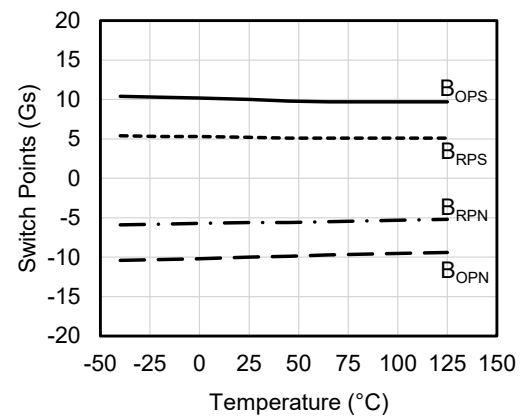


Figure 20. Switch points versus temperature ($V_{CC} = 3\text{ V}$)

TMR1308x Temperature Characteristics

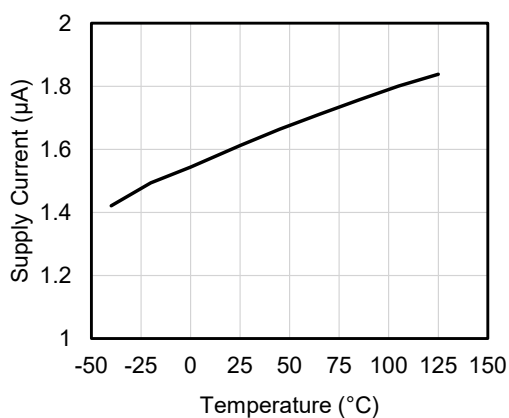


Figure 21. Supply current versus temperature ($V_{CC} = 3\text{ V}$)

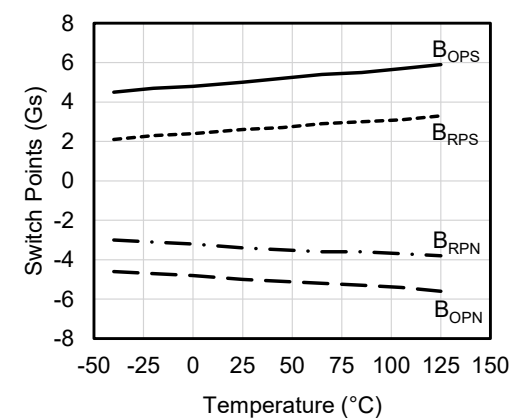


Figure 22. Switch points versus temperature ($V_{CC} = 3\text{ V}$)

9. Application Information

It is recommended to add a filter capacitor between the sensor power supply and ground (close to the sensor) to reduce external noise. As shown in Figure 23, the typical value is 0.1 μF .

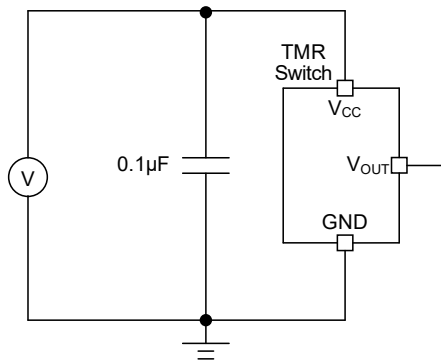


Figure 23. Application circuit diagram

The TMR130X series sensor chips are not suitable for driving power loads. The general method of use is utilizing the output voltage of V_{OUT} pin as a signal to input the MCU or drive a triode or MOS as shown in Figure 24.

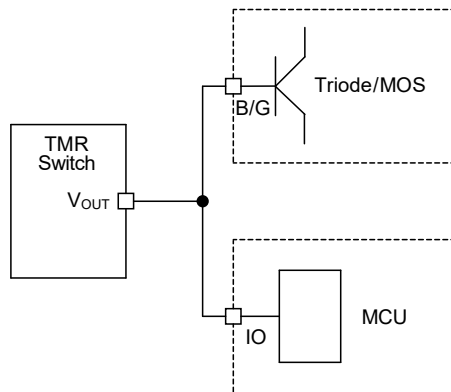


Figure 24. Application diagram for driving power load

Common failure conditions:

- The supply voltage exceeds the limit of absolute maximum ratings
- Absence of matching filter capacitor to power supply when the power supply is unstable, which can cause the product to restart repeatedly
- Using switch output V_{OUT} to control high-power relays, etc., and cause I_{SINK} and I_{SOURCE} exceeding the limit of absolute maximum ratings
- The external magnetic field exceeds the limit of absolute maximum ratings
- Operating in a humid environment for a long time, causing vapor penetration and increased power consumption
- Overheating when soldering
- Over bending of pins

10. Dimensions

SOT23-3 Package

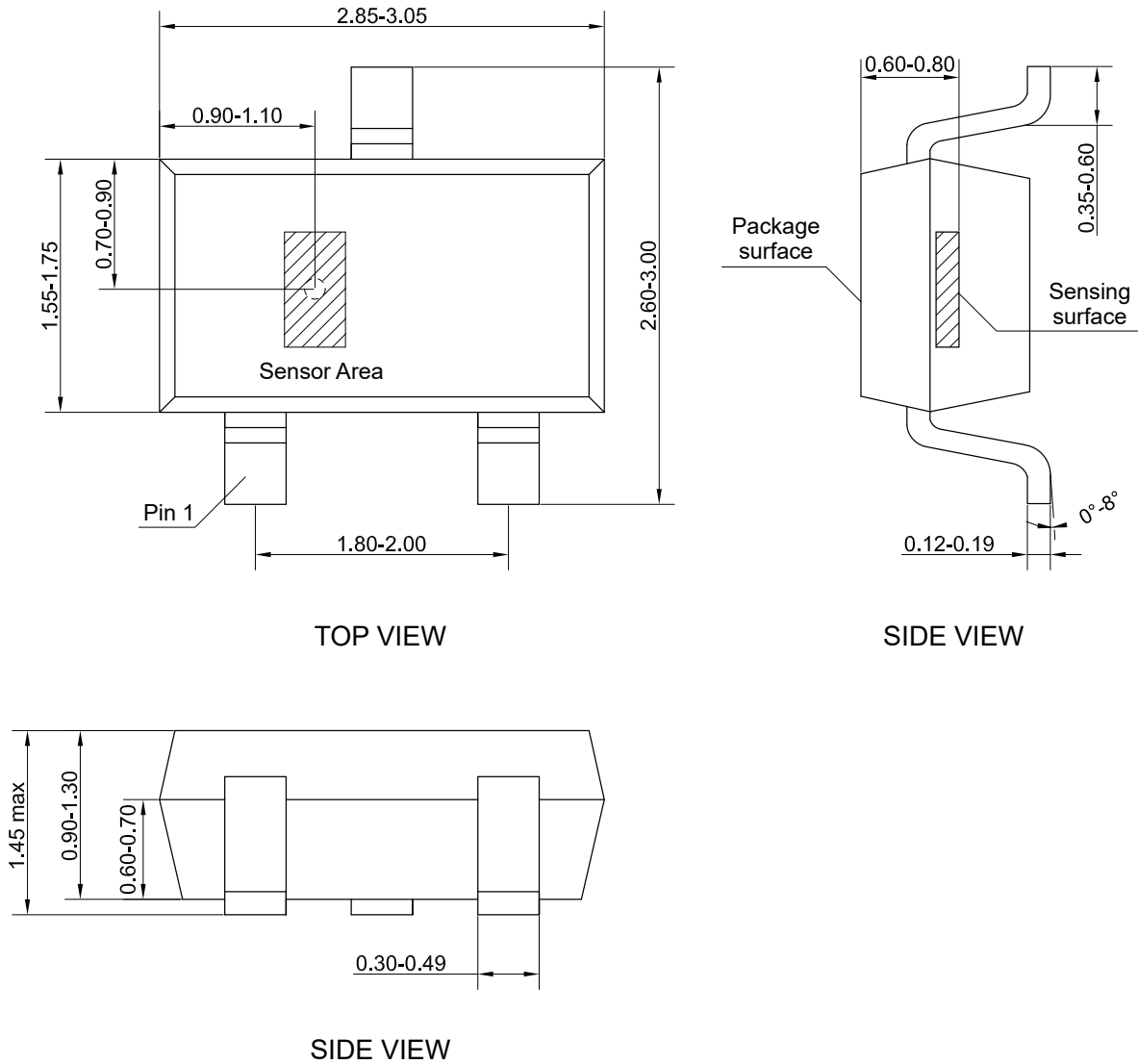


Figure 25. Package outline of SOT23-3 (unit: mm)

TO92S Package

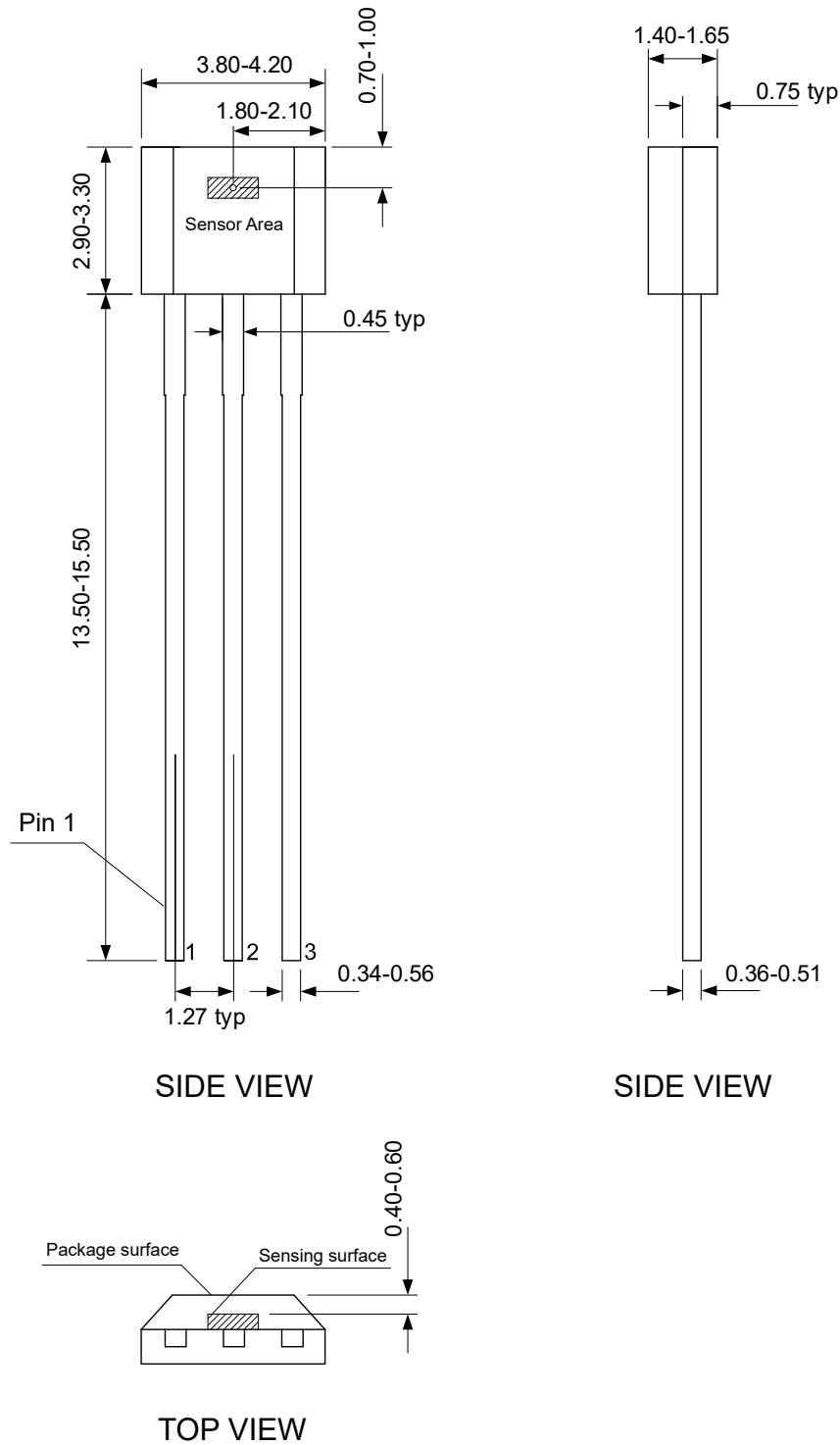


Figure 26. Package outline of TO92S (unit: mm)

LGA3L Package

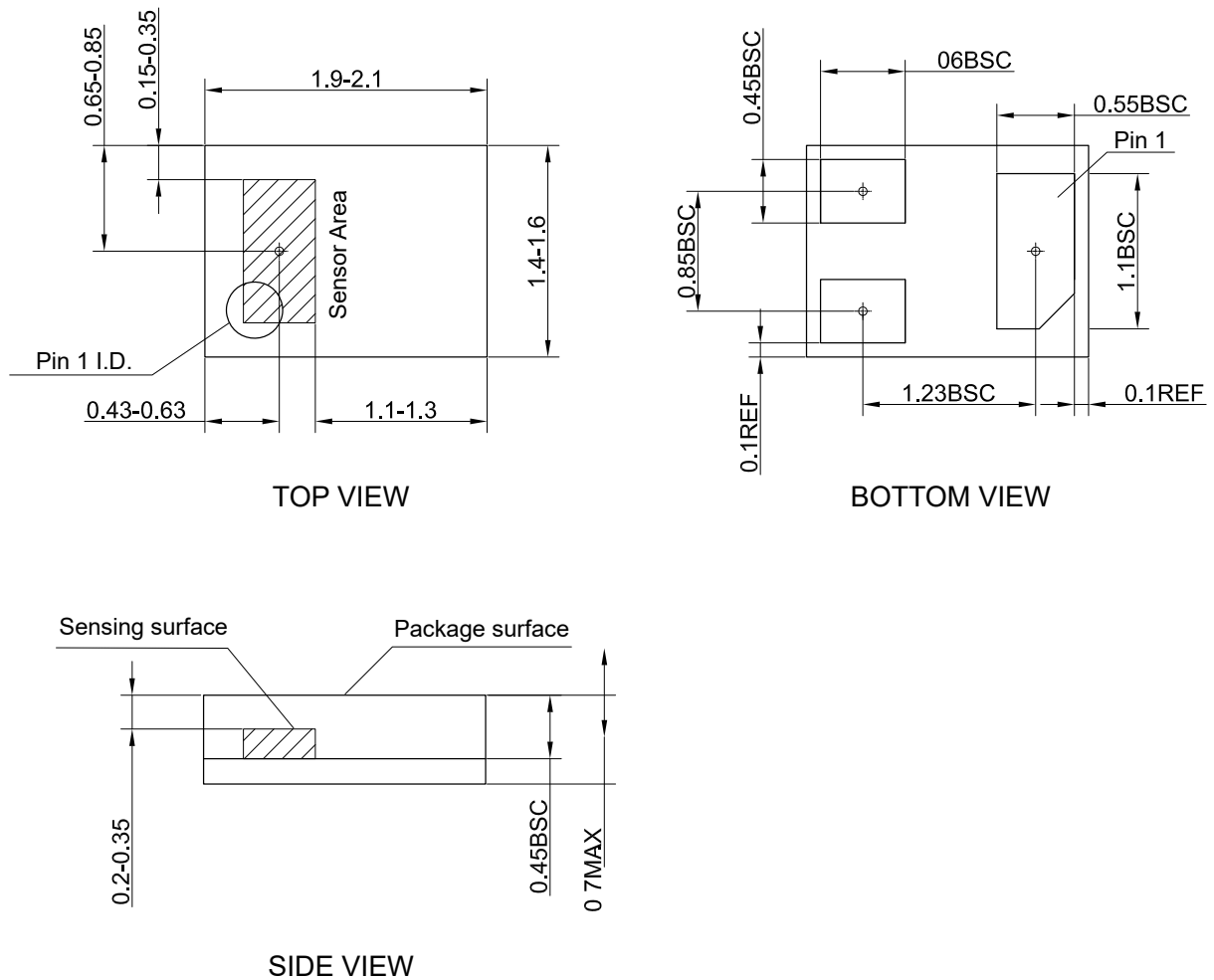


Figure 27. Package outline of LGA3L (unit: mm)

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